

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2684504

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>SEUNG KWON HONG</td> <td>01/13/2014</td> </tr> <tr> <td>HYUN GYU PARK</td> <td>01/13/2014</td> </tr> <tr> <td>IN HEE CHO</td> <td>01/13/2014</td> </tr> <tr> <td>NAM YANG LEE</td> <td>01/13/2014</td> </tr> <tr> <td>HYUK SOO LEE</td> <td>01/13/2014</td> </tr> </tbody> </table>		Name	Execution Date	SEUNG KWON HONG	01/13/2014	HYUN GYU PARK	01/13/2014	IN HEE CHO	01/13/2014	NAM YANG LEE	01/13/2014	HYUK SOO LEE	01/13/2014
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HYUK SOO LEE	01/13/2014												
RECEIVING PARTY DATA													
Name:	LG INNOTEK CO., LTD.												
Street Address:	SEOUL SQUARE, 416, HANGANG-DAERO, JUNG-GU												
City:	SEOUL												
State/Country:	KOREA, REPUBLIC OF												
Postal Code:	100-714												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14156117</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14156117								
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CORRESPONDENCE DATA													
Fax Number:	(352)372-5800												
Phone:	3523758100												
Email:	JL@SLEPATENTS.COM												
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>													
Correspondent Name:	JEFF LLOYD												
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Address Line 4:	GAINESVILLE, FLORIDA 32614-2950												
ATTORNEY DOCKET NUMBER:	WIP.LGI.155												
NAME OF SUBMITTER:	JEFF LLOYD												

Signature:	/JEFF LLOYD/
Date:	01/16/2014
Total Attachments: 3 source=Exec-Assgn-AF#page1.tif source=Exec-Assgn-AF#page2.tif source=Exec-Assgn-AF#page3.tif	

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1001, 500, 8, 117, 118, 119

**COMBINED DECLARATION (37 C.F.R. § 1.63) AND ASSIGNMENT**

As a below-named inventor, I hereby declare that:

I believe I am the original inventor or an original joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

Insert Title:

CIRCUIT BOARD AND FLAT PANEL DISPLAY INCLUDING  
THE SAME

the  
specification for which

- is attached hereto.
- was filed January 15, 2014, Serial No. 14/156,117.

The above-identified application was made or authorized to be made by me.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

**ASSIGNMENT**

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified above.

WHEREAS,

Insert

Assignee(s)

Name/Address:

**LG Innotek Co., Ltd.**  
Seoul Square, 416, Hangang-daero, Jung-gu, Seoul 100-714  
Republic of Korea

(hereinafter ASSIGNEE), is desirous of acquiring the entire right, title, and interest in and to said invention and in and to any Letters Patent which may be granted therefor in the United States and in any and all foreign countries;

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16:35:56 KST 147.96.0.0

NOW, THEREFORE, in view of valuable consideration, receipt of which is hereby acknowledged, we, the undersigned, have sold, assigned, and transferred, and by these presents do sell, assign, and transfer, unto said ASSIGNEE, its successors and assigns, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title, and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, and extensions thereof.

We hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to ASSIGNEE, as the assignee of the entire right, title, and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its successors and assigns.

FURTHER, we agree that we will communicate to said ASSIGNEE, or its representatives, any facts known to us respecting said invention; testify in any legal proceedings; sign all lawful papers; execute all divisional, continuation, substitution, renewal, and reissue applications; execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE; make all rightful oaths; and generally do everything possible to aid the said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

In witness whereof, executed by the undersigned on the date opposite the undersigned name.

Legal Name  
of inventor

HONG, Seung Kwon

Date:

2014.01.13

Inventor's  
Signature

*Hong Seung Kwon*

Additional inventors are being named on the   1   supplemental sheet(s) attached hereto.

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EPO/US/JP/... 147 (1/1)

**SUPPLEMENTAL SHEET FOR  
DECLARATION AND ASSIGNMENT**

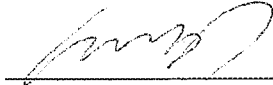
**ADDITIONAL INVENTOR(S)**  
Supplemental Sheet Page 1 of 1

LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name of inventor PARK, Hyun Gyu

Date: 2014. 01. 13

Inventor's Signature

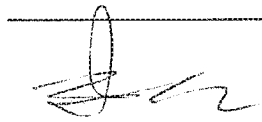


LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name of inventor CHO, In Hee

Date: 2014. 01. 13

Inventor's Signature

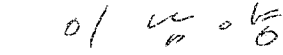


LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name of inventor LEE, Nam Yang

Date: 2014. 01. 13

Inventor's Signature



LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name of inventor LEE, Hyuk Soo

Date: 2014. 01. 13

Inventor's Signature



LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name of inventor

Date:

Inventor's Signature

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